

## SN54HC139, SN74HC139

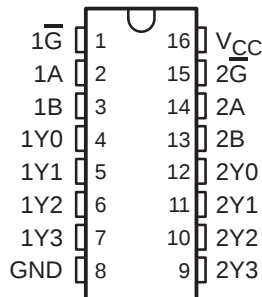
SCI S108D – DECEMBER 1982 – REVISED SEPTEMBER 2003

- Targeted Specifically for High-Speed Memory Decoders and Data-Transmission Systems
- Wide Operating Voltage Range of 2 V to 6 V
- Outputs Can Drive Up To 10 LSTTL Loads
- Low Power Consumption, 80- $\mu$ A Max  $I_{CC}$
- Typical  $t_{pd} = 10$  ns
- $\pm 4$ -mA Output Drive at 5 V
- Low Input Current of 1  $\mu$ A Max
- Incorporate Two Enable Inputs to Simplify Cascading and/or Data Reception

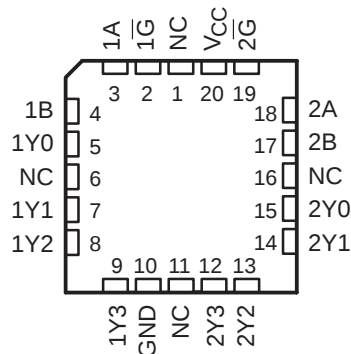
**description/ordering information**

The 'HC139 devices are designed for high-performance memory-decoding or data-routing applications requiring very short propagation delay times. In high-performance memory systems, these decoders can minimize the effects of system decoding. When employed with high-speed memories utilizing a fast enable circuit, the delay time of these decoders and the enable time of the memory usually are less than the typical access time of the memory. This means that the effective system delay introduced by the decoders is negligible.

SN54HC139 . . . J OR W PACKAGE  
SN74HC139 . . . D, DB, N, NS, OR PW PACKAGE  
(TOP VIEW)



SN54HC139 . . . FK PACKAGE  
(TOP VIEW)



NC – No internal connection

## ORDERING INFORMATION

| T <sub>A</sub> | PACKAGE <sup>†</sup> | PACKAGE <sup>†</sup> | ORDERABLE<br>PART NUMBER | TOP-SIDE<br>MARKING |
|----------------|----------------------|----------------------|--------------------------|---------------------|
| -40°C to 85°C  | PDIP – N             | Tube of 25           | SN74HC139N               | SN74HC139N          |
|                | SOIC – D             | Tube of 40           | SN74HC139D               | HC139               |
|                |                      | Reel of 2500         | SN74HC139DR              |                     |
|                |                      | Reel of 250          | SN74HC139DT              |                     |
|                | SOP – NS             | Reel of 2000         | SN74HC139NSR             | HC139               |
|                | SSOP – DB            | Reel of 2000         | SN74HC139DBR             | HC139               |
|                | TSSOP – PW           | Tube of 90           | SN74HC139PW              | HC139               |
|                |                      | Reel of 2000         | SN74HC139PWR             |                     |
| Reel of 250    |                      | SN74HC139PWT         |                          |                     |
| -55°C to 125°C | CDIP – J             | Tube of 25           | SNJ54HC139J              | SNJ54HC139J         |
|                | CFP – W              | Tube of 150          | SNJ54HC139W              | SNJ54HC139W         |
|                | LCCC – FK            | Tube of 55           | SNJ54HC139FK             | SNJ54HC139FK        |

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/sc/package](http://www.ti.com/sc/package).



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# SN54HC139, SN74HC139

## DUAL 2-LINE TO 4-LINE DECODERS/DEMULTIPLEXERS

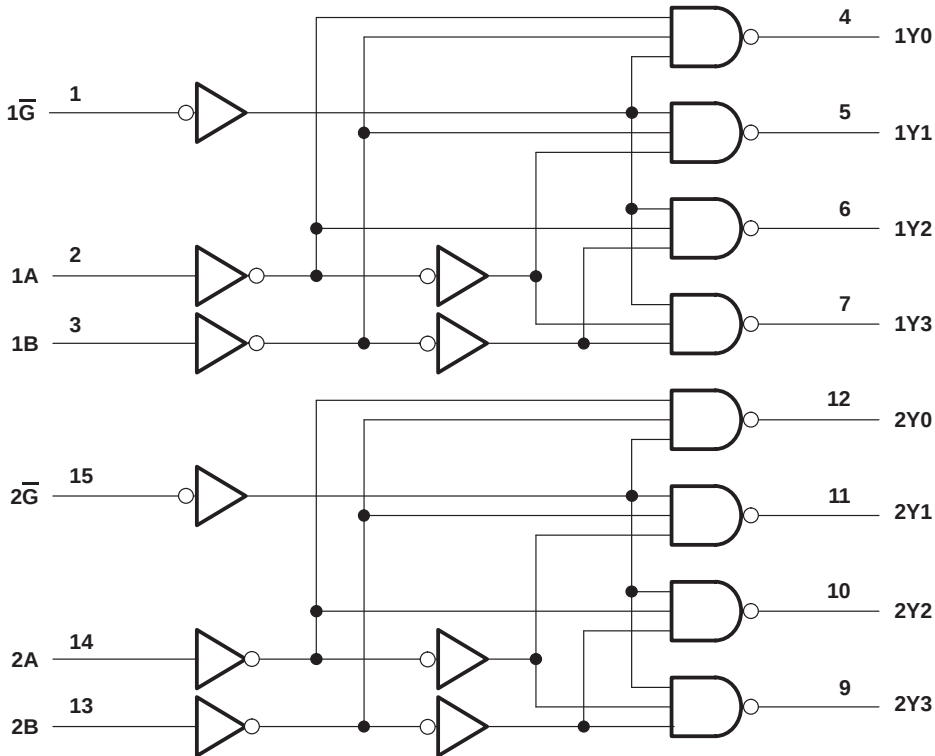
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### description/ordering information (continued)

The 'HC139 devices comprise two individual 2-line to 4-line decoders in a single package. The active-low enable ( $\overline{G}$ ) input can be used as a data line in demultiplexing applications. These decoders/demultiplexers feature fully buffered inputs, each of which represents only one normalized load to its driving circuit.

| FUNCTION TABLE |        |   |         |    |    |    |
|----------------|--------|---|---------|----|----|----|
| INPUTS         |        |   | OUTPUTS |    |    |    |
| $\overline{G}$ | SELECT |   | Y0      | Y1 | Y2 | Y3 |
| B              | A      |   |         |    |    |    |
| H              | X      | X | H       | H  | H  | H  |
| L              | L      | L | L       | H  | H  | H  |
| L              | L      | H | H       | L  | H  | H  |
| L              | H      | L | H       | H  | L  | H  |
| L              | H      | H | H       | H  | H  | L  |

### logic diagram (positive logic)



Pin numbers shown are for the D, DB, J, N, NS, PW, and W packages.

# SN54HC139, SN74HC139

## DUAL 2-LINE TO 4-LINE DECODERS/DEMULTIPLEXERS

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### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

|                                                                             |                |
|-----------------------------------------------------------------------------|----------------|
| Supply voltage range, $V_{CC}$                                              | –0.5 V to 7 V  |
| Input clamp current, $I_{IK}$ ( $V_I < 0$ or $V_I > V_{CC}$ ) (see Note 1)  | ±20 mA         |
| Output clamp current, $I_{OK}$ ( $V_O < 0$ or $V_O > V_{CC}$ ) (see Note 1) | ±20 mA         |
| Continuous output current, $I_O$ ( $V_O = 0$ to $V_{CC}$ )                  | ±25 mA         |
| Continuous current through $V_{CC}$ or GND                                  | ±50 mA         |
| Package thermal impedance, $\theta_{JA}$ (see Note 2): D package            | 73°C/W         |
| DB package                                                                  | 82°C/W         |
| N package                                                                   | 67°C/W         |
| NS package                                                                  | 64°C/W         |
| PW package                                                                  | 108°C/W        |
| Storage temperature range, $T_{stg}$                                        | –65°C to 150°C |

<sup>†</sup> Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.  
2. The package thermal impedance is calculated in accordance with JESD 51-7.

### recommended operating conditions (see Note 3)

|                 |                                 |                         | SN54HC139 |                 |     | SN74HC139 |                 |     | UNIT |   |
|-----------------|---------------------------------|-------------------------|-----------|-----------------|-----|-----------|-----------------|-----|------|---|
|                 |                                 |                         | MIN       | NOM             | MAX | MIN       | NOM             | MAX |      |   |
| V <sub>CC</sub> | Supply voltage                  |                         | 2         | 5               | 6   | 2         | 5               | 6   | V    |   |
| V <sub>IH</sub> | High-level input voltage        | V <sub>CC</sub> = 2 V   | 1.5       |                 |     | 1.5       |                 |     | V    |   |
|                 |                                 | V <sub>CC</sub> = 4.5 V | 3.15      |                 |     | 3.15      |                 |     |      |   |
|                 |                                 | V <sub>CC</sub> = 6 V   | 4.2       |                 |     | 4.2       |                 |     |      |   |
| V <sub>IL</sub> | Low-level input voltage         | V <sub>CC</sub> = 2 V   | 0.5       |                 |     | 0.5       |                 |     | V    |   |
|                 |                                 | V <sub>CC</sub> = 4.5 V | 1.35      |                 |     | 1.35      |                 |     |      |   |
|                 |                                 | V <sub>CC</sub> = 6 V   | 1.8       |                 |     | 1.8       |                 |     |      |   |
| V <sub>I</sub>  | Input voltage                   |                         | 0         | V <sub>CC</sub> |     | 0         | V <sub>CC</sub> |     |      | V |
| V <sub>O</sub>  | Output voltage                  |                         | 0         | V <sub>CC</sub> |     | 0         | V <sub>CC</sub> |     |      | V |
| Δt/Δv           | Input transition rise/fall time | V <sub>CC</sub> = 2 V   | 1000      |                 |     | 1000      |                 |     | ns   |   |
|                 |                                 | V <sub>CC</sub> = 4.5 V | 500       |                 |     | 500       |                 |     |      |   |
|                 |                                 | V <sub>CC</sub> = 6 V   | 400       |                 |     | 400       |                 |     |      |   |
| T <sub>A</sub>  | Operating free-air temperature  |                         | −55       | 125             |     | −40       | 85              |     | °C   |   |

NOTE 3: All unused inputs of the device must be held at  $V_{CC}$  or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.



# SN54HC139, SN74HC139

## DUAL 2-LINE TO 4-LINE DECODERS/DEMULTIPLEXERS

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER       | TEST CONDITIONS                                           |                           | V <sub>CC</sub> | T <sub>A</sub> = 25°C |       |      | SN54HC139 |       | SN74HC139 |       | UNIT |
|-----------------|-----------------------------------------------------------|---------------------------|-----------------|-----------------------|-------|------|-----------|-------|-----------|-------|------|
|                 |                                                           |                           |                 | MIN                   | TYP   | MAX  | MIN       | MAX   | MIN       | MAX   |      |
| V <sub>OH</sub> | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>       | I <sub>OH</sub> = -20 µA  | 2 V             | 1.9                   | 1.998 |      | 1.9       |       | 1.9       |       | V    |
|                 |                                                           |                           | 4.5 V           | 4.4                   | 4.499 |      | 4.4       |       | 4.4       |       |      |
|                 |                                                           |                           | 6 V             | 5.9                   | 5.999 |      | 5.9       |       | 5.9       |       |      |
|                 |                                                           | I <sub>OH</sub> = -4 mA   | 4.5 V           | 3.98                  | 4.3   |      | 3.7       |       | 3.84      |       |      |
|                 |                                                           | I <sub>OH</sub> = -5.2 mA | 6 V             | 5.48                  | 5.8   |      | 5.2       |       | 5.34      |       |      |
| V <sub>OL</sub> | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>       | I <sub>OL</sub> = 20 µA   | 2 V             |                       | 0.002 | 0.1  |           | 0.1   |           | 0.1   | V    |
|                 |                                                           |                           | 4.5 V           |                       | 0.001 | 0.1  |           | 0.1   |           | 0.1   |      |
|                 |                                                           |                           | 6 V             |                       | 0.001 | 0.1  |           | 0.1   |           | 0.1   |      |
|                 |                                                           | I <sub>OL</sub> = 4 mA    | 4.5 V           |                       | 0.17  | 0.26 |           | 0.4   |           | 0.33  |      |
|                 |                                                           | I <sub>OL</sub> = 5.2 mA  | 6 V             |                       | 0.15  | 0.26 |           | 0.4   |           | 0.33  |      |
| I <sub>I</sub>  | V <sub>I</sub> = V <sub>CC</sub> or 0                     |                           | 6 V             |                       | ±0.1  | ±100 |           | ±1000 |           | ±1000 | nA   |
| I <sub>CC</sub> | V <sub>I</sub> = V <sub>CC</sub> or 0, I <sub>O</sub> = 0 |                           | 6 V             |                       |       | 8    |           | 160   |           | 80    | µA   |
| C <sub>i</sub>  |                                                           |                           | 2 V to 6 V      |                       | 3     | 10   |           | 10    |           | 10    | pF   |

switching characteristics over recommended operating free-air temperature range, C<sub>L</sub> = 50 pF (unless otherwise noted) (see Figure 1)

| PARAMETER       | FROM (INPUT)   | TO (OUTPUT) | V <sub>CC</sub> | T <sub>A</sub> = 25°C |     |     | SN54HC139 |     | SN74HC139 |     | UNIT |
|-----------------|----------------|-------------|-----------------|-----------------------|-----|-----|-----------|-----|-----------|-----|------|
|                 |                |             |                 | MIN                   | TYP | MAX | MIN       | MAX | MIN       | MAX |      |
| t <sub>pd</sub> | A or B         | Y           | 2 V             |                       | 47  | 175 |           | 255 |           | 220 | ns   |
|                 |                |             | 4.5 V           |                       | 14  | 35  |           | 51  |           | 44  |      |
|                 |                |             | 6 V             |                       | 12  | 30  |           | 44  |           | 38  |      |
|                 | $\overline{G}$ | Y           | 2 V             |                       | 39  | 175 |           | 255 |           | 220 |      |
|                 |                |             | 4.5 V           |                       | 11  | 35  |           | 51  |           | 44  |      |
|                 |                |             | 6 V             |                       | 10  | 30  |           | 44  |           | 38  |      |
| t <sub>t</sub>  |                | Y           | 2 V             |                       | 38  | 75  |           | 110 |           | 95  | ns   |
|                 |                |             | 4.5 V           |                       | 8   | 15  |           | 22  |           | 19  |      |
|                 |                |             | 6 V             |                       | 6   | 13  |           | 19  |           | 16  |      |

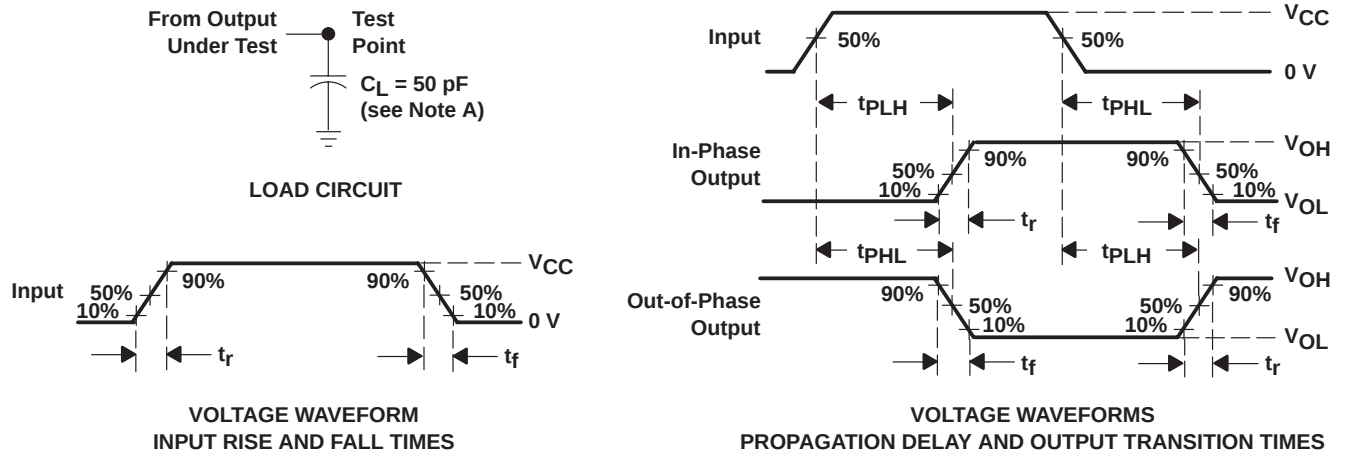
operating characteristics, T<sub>A</sub> = 25°C

| PARAMETER       |                                           | TEST CONDITIONS | TYP | UNIT |
|-----------------|-------------------------------------------|-----------------|-----|------|
| C <sub>pd</sub> | Power dissipation capacitance per decoder | No load         | 25  | pF   |

# SN54HC139, SN74HC139 DUAL 2-LINE TO 4-LINE DECODERS/DEMULTIPLEXERS

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## PARAMETER MEASUREMENT INFORMATION



- NOTES: A.  $C_L$  includes probe and test-fixture capacitance.  
 B. Phase relationships between waveforms were chosen arbitrarily. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 1 \text{ MHz}$ ,  $Z_O = 50 \Omega$ ,  $t_r = 6 \text{ ns}$ ,  $t_f = 6 \text{ ns}$ .  
 C. The outputs are measured one at a time with one input transition per measurement.  
 D.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .

Figure 1. Load Circuit and Voltage Waveforms

**PACKAGING INFORMATION**

| Orderable Device | Status <sup>(1)</sup> | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| 84092012A        | ACTIVE                | LCCC         | FK              | 20   | 1           | TBD                     | Call TI          | Level-NC-NC-NC               |
| 8409201EA        | ACTIVE                | CDIP         | J               | 16   | 1           | TBD                     | Call TI          | Level-NC-NC-NC               |
| 8409201FA        | ACTIVE                | CFP          | W               | 16   | 1           | TBD                     | Call TI          | Level-NC-NC-NC               |
| JM38510/65803BEA | ACTIVE                | CDIP         | J               | 16   | 1           | TBD                     | Call TI          | Level-NC-NC-NC               |
| JM38510/65803BFA | ACTIVE                | CFP          | W               | 16   | 1           | TBD                     | Call TI          | Level-NC-NC-NC               |
| SN54HC139J       | ACTIVE                | CDIP         | J               | 16   | 1           | TBD                     | Call TI          | Level-NC-NC-NC               |
| SN74HC139D       | ACTIVE                | SOIC         | D               | 16   | 40          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74HC139DBR     | ACTIVE                | SSOP         | DB              | 16   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74HC139DBRE4   | ACTIVE                | SSOP         | DB              | 16   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74HC139DE4     | ACTIVE                | SOIC         | D               | 16   | 40          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74HC139DR      | ACTIVE                | SOIC         | D               | 16   | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74HC139DRE4    | ACTIVE                | SOIC         | D               | 16   | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74HC139DT      | ACTIVE                | SOIC         | D               | 16   | 250         | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74HC139DTE4    | ACTIVE                | SOIC         | D               | 16   | 250         | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74HC139N       | ACTIVE                | PDIP         | N               | 16   | 25          | Pb-Free (RoHS)          | CU NIPDAU        | Level-NC-NC-NC               |
| SN74HC139N3      | OBSOLETE              | PDIP         | N               | 16   |             | TBD                     | Call TI          | Call TI                      |
| SN74HC139NSR     | ACTIVE                | SO           | NS              | 16   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74HC139NSRE4   | ACTIVE                | SO           | NS              | 16   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74HC139PW      | ACTIVE                | TSSOP        | PW              | 16   | 90          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74HC139PWE4    | ACTIVE                | TSSOP        | PW              | 16   | 90          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74HC139PWG4    | ACTIVE                | TSSOP        | PW              | 16   | 90          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74HC139PWLE    | OBSOLETE              | TSSOP        | PW              | 16   |             | TBD                     | Call TI          | Call TI                      |
| SN74HC139PWR     | ACTIVE                | TSSOP        | PW              | 16   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74HC139PWRE4   | ACTIVE                | TSSOP        | PW              | 16   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74HC139PWRG4   | ACTIVE                | TSSOP        | PW              | 16   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74HC139PWT     | ACTIVE                | TSSOP        | PW              | 16   | 250         | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74HC139PWTE4   | ACTIVE                | TSSOP        | PW              | 16   | 250         | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74HC139PWTG4   | ACTIVE                | TSSOP        | PW              | 16   | 250         | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |

| Orderable Device | Status <sup>(1)</sup> | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| SNJ54HC139FK     | ACTIVE                | LCCC         | FK              | 20   | 1           | TBD                     | Call TI          | Level-NC-NC-NC               |
| SNJ54HC139J      | ACTIVE                | CDIP         | J               | 16   | 1           | TBD                     | Call TI          | Level-NC-NC-NC               |
| SNJ54HC139W      | ACTIVE                | CFP          | W               | 16   | 1           | TBD                     | Call TI          | Level-NC-NC-NC               |

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSELETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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J (R-GDIP-T\*\*)

14 LEADS SHOWN

# CERAMIC DUAL IN-LINE PACKAGE



| PINS **<br>DIM | 14                     | 16                     | 18                     | 20                     |
|----------------|------------------------|------------------------|------------------------|------------------------|
| A              | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC |
| B MAX          | 0.785<br>(19,94)       | .840<br>(21,34)        | 0.960<br>(24,38)       | 1.060<br>(26,92)       |
| B MIN          | —                      | —                      | —                      | —                      |
| C MAX          | 0.300<br>(7,62)        | 0.300<br>(7,62)        | 0.310<br>(7,87)        | 0.300<br>(7,62)        |
| C MIN          | 0.245<br>(6,22)        | 0.245<br>(6,22)        | 0.220<br>(5,59)        | 0.245<br>(6,22)        |

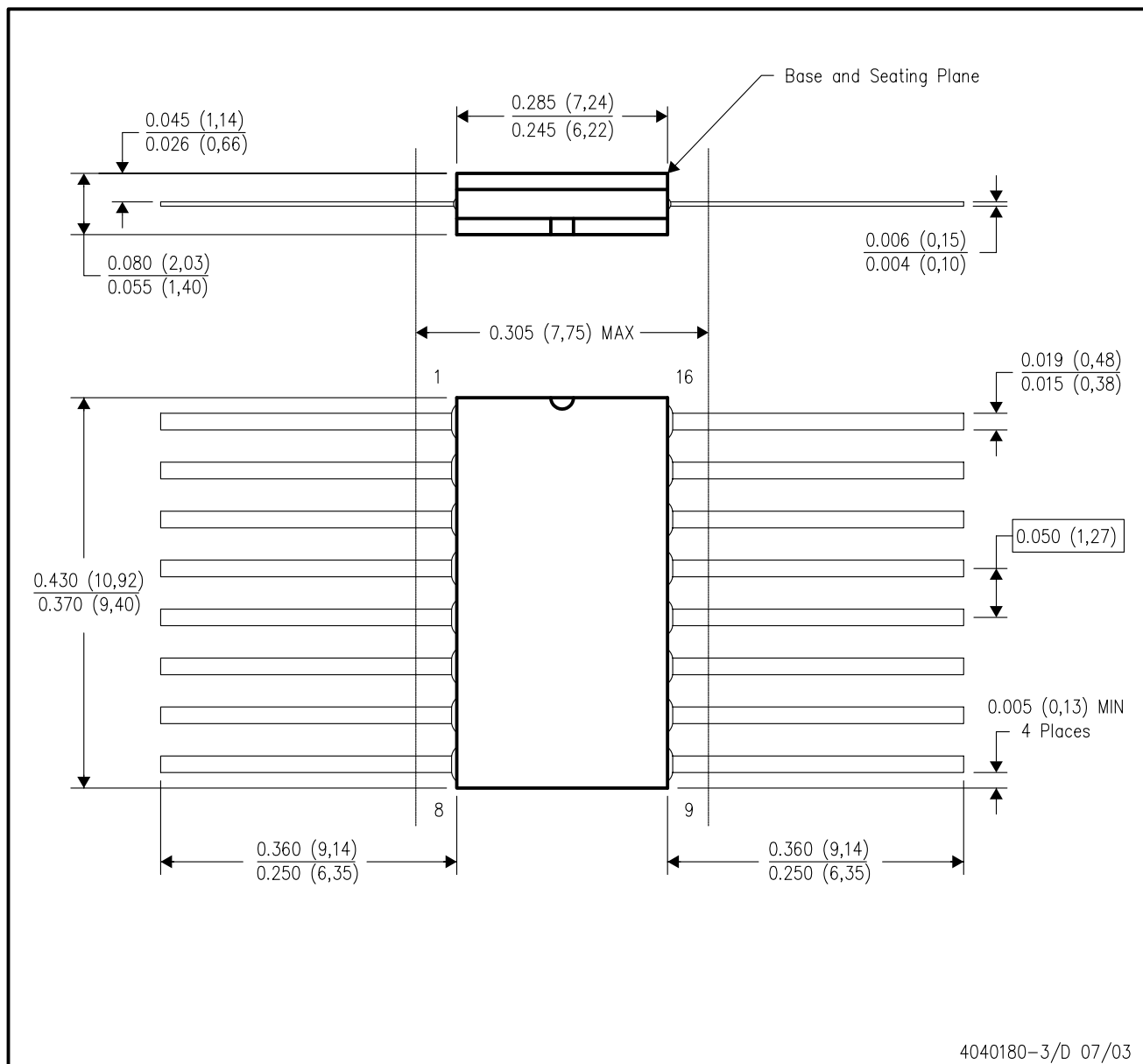


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- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package is hermetically sealed with a ceramic lid using glass frit.
  - D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
  - E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

W (R-GDFP-F16)

CERAMIC DUAL FLATPACK



- NOTES:
- All linear dimensions are in inches (millimeters).
  - This drawing is subject to change without notice.
  - This package can be hermetically sealed with a ceramic lid using glass frit.
  - Index point is provided on cap for terminal identification only.
  - Falls within MIL STD 1835 GDFP1-F16 and JEDEC MO-092AC

FK (S-CQCC-N\*\*)

LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN

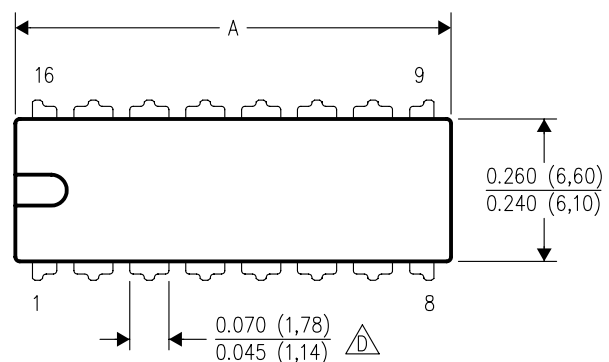


- NOTES:
- All linear dimensions are in inches (millimeters).
  - This drawing is subject to change without notice.
  - This package can be hermetically sealed with a metal lid.
  - The terminals are gold plated.
  - Falls within JEDEC MS-004

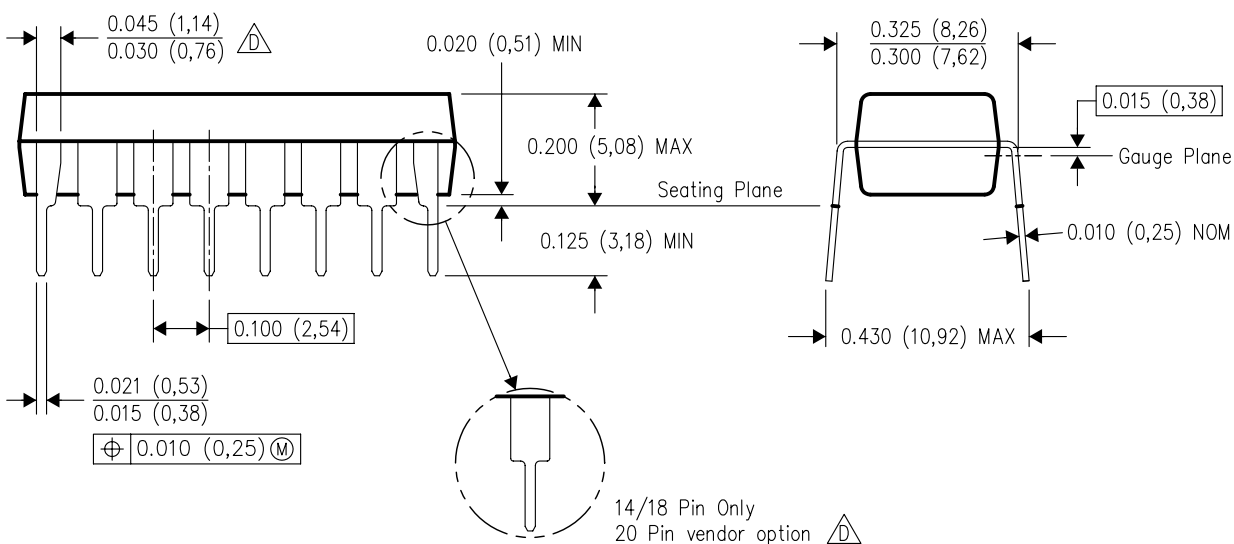
N (R-PDIP-T\*\*)

16 PINS SHOWN

## PLASTIC DUAL-IN-LINE PACKAGE



| PINS **<br>DIM      | 14               | 16               | 18               | 20               |
|---------------------|------------------|------------------|------------------|------------------|
| A MAX               | 0.775<br>(19,69) | 0.775<br>(19,69) | 0.920<br>(23,37) | 1.060<br>(26,92) |
| A MIN               | 0.745<br>(18,92) | 0.745<br>(18,92) | 0.850<br>(21,59) | 0.940<br>(23,88) |
| MS-001<br>VARIATION | AA               | BB               | AC               | AD               |



4040049/E 12/2002

- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  -  Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
  -  The 20 pin end lead shoulder width is a vendor option, either half or full width.

## D (R-PDSO-G16)

## PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- All linear dimensions are in inches (millimeters).
  - This drawing is subject to change without notice.
  - Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
  - Falls within JEDEC MS-012 variation AC.

# MECHANICAL DATA

NS (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

## DB (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE

28 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-150

## PW (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-153

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